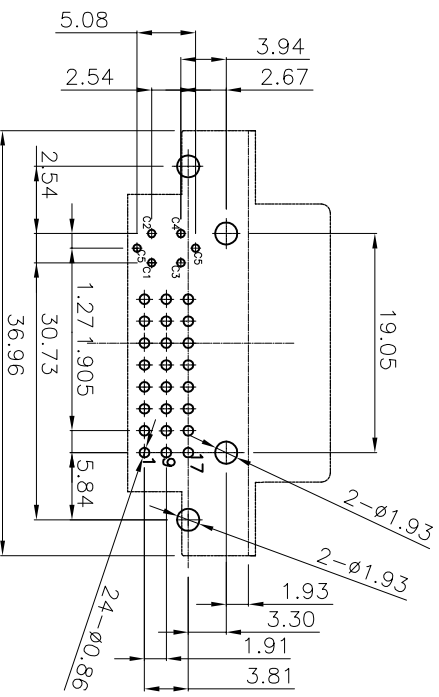
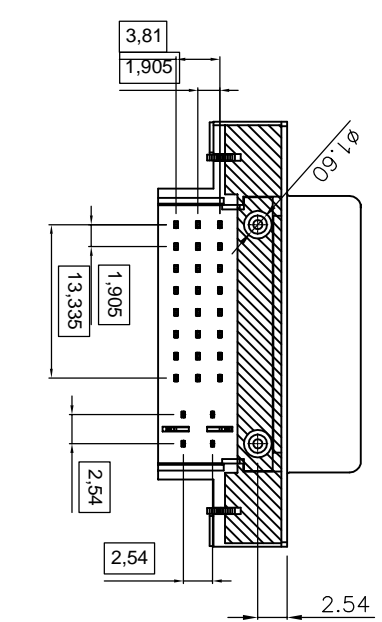


1. HOUSING: THERMOPLASTIC (UL 94V-0).
2. COVER: THERMOPLASTIC (UL 94V-0).
3. TERMINAL: COPPER ALLOY.  
GOLD PLATED ON CONTACT AREA,  
TIN PLATED ON SOLDER TAILS,  
NICKEL UNDER PLATED OVERALL.
4. BOARD LOCK: SPCC, TIN PLATED OVER NICKEL.
5. SHELL: SPCC, NICKEL PLATED OVERALL.
6. RIVET: Zn ALLOY, NICKEL PLATED OVERALL.



RECOMMEND PCB LAYOUT  
TOLERANCE: ±0.05  
TOP VIEW

X. ±0.30	APPD.	Mr.WU	TITLE:
X ±0.20	CHKD:	Mr.WU	29PIN 焊板式 母头+B型铜箔
.XXX±0.05	Dr:	Gus chong	PART NO: JIONS-0034
X ±1"	UNITS:	mm	SCALE: 1:1
	DWG NO:	WWW.JIONS.COM.CN	SHEET:10/1

REV	ECN NO	DESCRIPTION	DATE
A	JIONS-DVI-0007		2011/02/01

Jions 北京玖恩启明电子科技有限公司

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